National Semiconductor

DP117-X/DP117-XR/ μ A117-X/ μ A117-XR Series Winchester Disk Read/Write Preamplifiers

General Description

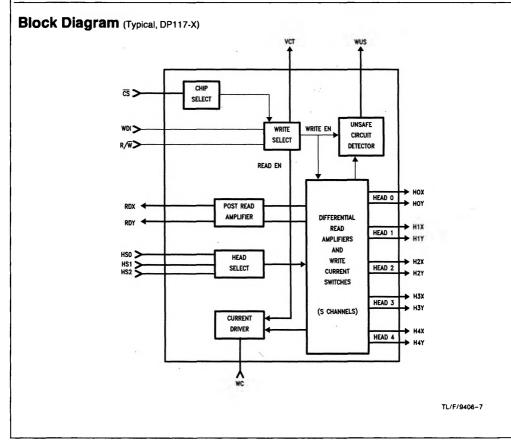
The DP117-X/DP117-XR, μ A117-X/ μ A117-XR Series High Performance Read/Write Preamplifiers are intended for use in Winchester disk drives which employ center tapped ferrite or manganese-zinc read/write heads. The circuit can interface with up to eight read/write heads which makes it ideal for multi-platter disk drive designs. Designed to reside in the Head/Disk Assembly (HDA) of Winchester disk drives, the Read/Write Preamplifiers provide termination, gain, and output buffering for the disk heads as well as switched write current. Certain write fault conditions are detected and reported to protect recording integrity. The parts are available with internal damping resistor (DP117-R) and without internal damping resistor (DP117).

Features

- Wide bandwidth, high gain, low noise
- Up to eight read/write channels
- Internal write fault condition detection
- 5.0V and 12V power supply voltages
- Independent read and write data lines
- TTL control and data logic levels
- Externally programmable write current
- Available with internal damping resistor
- Compatible with SSI 117 family

Part Selection

Device Code	Channels
μA117-2	2
μA117-4	4
μA117-6	6



Absolute Maximum Ratings All voltages referenced to GND

If Military/Aerospace specified	••••••	DC Supply Voltage	
please contact the National		(V _{DD1})	-0.3V to +14V
Office/Distributors for availability	y and specifications.	(V _{DD2})	-0.3V to +14V
Storage Temperature Range		(V _{CC})	-0.3V to +6.0V
Ceramic	-65°C to +175°C	Digital Input Voltage Range	
Plastic	-65°C to +150°C	(V _{IN})	-0.3V to V _{CC} + 0.3V
Operating Junction Temperature Ra	inge +25°C to +135°C	Head Port Voltage Range	
Lead Temperature		(V _H)	-0.3V to V _{DD} + 0.3V
Ceramic (Soldering, 60 seconds)	300°C	WUS Port Voltage Range	
Plastic (Soldering, 10 seconds)	265°C	(V _{WUS})	-0.3V to +14V
Internal Power Dissipation (Notes 1	& 2)	Write Current (I _W)	60 mA
28L-Ceramic DIP	2.50W	Output Current (In)	
24L-Ceramic DIP	1.95W	RDX, RDY	— 10 mA
18L-Ceramic DIP	1.58W	VCT	—60 mA
24L-Brazed Flatpak	0.97W	WUS	+ 12 mA
24L-Ceramic Flatpak	0.90W		
28L-PLCC	1.39W	Recommended Opera	nting
Supply Voltage (V _{CC1})	6.0V	Conditions	
Supply Voltage (V _{CC2})	15V	DC Supply Voltage	
Write Current (IWC)	70 mA	(V _{DD1})	12V ±10%
Input Voltage Range		(V _{DD2})	6.5V to VDD1
Head Select (HS0, HS1, HS2)	-0.4V to V _{CC1} + 0.3V	(V _{CC})	5.0V ± 10%
Write Current (WC)		Head Inductance (Lh)	5.0 μH to 15 μH
Voltage in read and idle modes.		Damping Resistor (External) (RD)	500Ω to 2000Ω
(Write mode must be current		RCT Resistor (RCT)	$90\Omega \pm 5.05 (1/2W)$
limited to -70 mA)	-0.3V to V _{CC1} + 0.3V	. ,	
Chip Select (CS)	-0.4V to V _{CC1} + 0.3V	Write Current (I _W)	25 mA to 50 mA
Read/Write (R/W)	-0.4V to V _{CC1} + 0.3V	RDX, RDY Output Current (I _O)	0 μA to 100 μA

Note 2: Ratings apply to ambient temperature at 25°C. Above this temperature, derate the 28L-Ceramic DIP at 16.7 mW/°C, the 24L-Ceramic DIP at 13 mW/°C, the 18L-Ceramic DIP at 10.5 mW/°C, the 24L-Brazed Flatpak at 6.5 mW/°C, the 24L-Ceramic Flatpak at 6.0 mW/°C, and the 28L-PLCC at 11.2 mW/°C.

DC Characteristics $25^{\circ}C \le T_J < 125^{\circ}C$, $V_{DD1} = 12V$, $V_{CC} = 5.0V$, unless otherwise specified

Symbol		Parameter	Con	ditions	Min	Max	Unite
lcc	C Supply C	urrent	Read/Idle Mod	Read/Idle Mode		25	mA
			Write Mode			30	- The v
IDD	Supply Cu	urrent	idle Mode			25	
			Read Mode			50	mA
			Write Mode	Write Mode		30 + I _W	
PC	Power Co	Power Consumption		Idle Mode		400	
				Read Mode		600	
				Write Mode, $I_W = 50 \text{ mA}$ RCT = 90 Ω RCT = 0 Ω		850 1050	mW
VIL	Digital	Input Voltage LOW			-0.3	0.8	V
VIH	Inputs	Input Voltage HIGH			2.0	$V_{\rm CC}$ + 0.3	V
կլ]	Input Current LOW	$V_{IL} = 0.8V$		-0.4		mA
кн		Input Current HIGH	V _{IH} = 2.0V			100	μΑ
V _{OL}	WUS Out	put	$I_{OL} = 8.0 \text{ mA}$			0.5	V
юн]		V _{OH} = 5.0V			100	μA
V _{CT}	Center Ta	Center Tap Voltage			4	l.0 (typ)	V
			Write Mode		6	6.0 (typ)	v

Write Characteristics $v_{DD1} = 12V$, $v_{CC} = 5.0V$, $I_W = 45$ mA, Lh = 10 μ H, f (I	Data) = 5.0 MHz, CL (RDX, RDY)
\leq 20 pF, R _{D EXT} = 750 Ω or R _{D INT} , unless otherwise specified	÷.

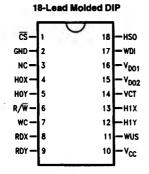
Parameter	Conditions	Min	Max	Units
Write Current Range		10	50	mA
Write Current Constant "K"		133	147	v
Differential Head Voltage Swing		5.7		V (pk)
Unselected Differential Head Current			2.0	mA (pk)
Differential Output Capacitance			15	pF
Differential Output Resistance	Without Internal Resistors	10k		Ω
- <u>-</u> -	With Internal Resistors	538	1.0k	46
WDI Transition Frequency	WUS = LOW	400	(typ)	kHz
Iwc to Head Current Gain		18	(typ)	mA/mA

Read Characteristics $V_{DD1} = 12V$, $V_{CC} = 5.0V$, $Lh = 10 \mu$ H, f (Data) = 5.0 MHz, CL (RDX, RDY) $\leq 20 p$ F, (V_{in} is referenced to V_{CT}), R_{D EXT} = 750 Ω or R_{D INT}, unless otherwise specified

Parameter	Conditions		Min	Max	Unit
Differential Voltage Gain	$V_{IN} = 1.0 \text{ mV}_{p-p}$ at 300 kHz RL (RDX), RL (RDY) = 1.0 k Ω		80	120	v/v
Dynamic Range	Input Voltage, V _I , where gain falls by 10%. V _{IN} = V _I + 0.5 mV _{p-p} at 300 kHz		-2.0	2.0	mV
Bandwidth (-3 dB)	Zs < 5.0Ω, V _{IN}	$= 1.0 \text{ mV}_{p-p}$	30		MHz
Input Noise Voltage	BW = 15 MHz, Lh = 0, Rh = 0			2.1	nV/√H:
Differential Input Capacitance	f = 5.0 MHz			23	рF
Differential Input Resistance	f = 5.0 MHz	Without Internal Resistors	2k		Ω
11		With Internal Resistors	440	850	32
Input Bias Current				45	μΑ
Common Mode Rejection Ratio	$V_{CM} = V_{CT} + 100 \text{ mV}_{p-p} \text{ at } 5.0 \text{ MHz}$		50		dB
Power Supply Rejection Ratio	100 mV _{p-p} at 5.0 MHz on V _{DD1} , V _{DD2} or V _{CC}		45		dB
Channel Separation	Unselected Channels: $V_{IN} = 100 \text{ mV}_{p-p}$ at 5.0 MHz and Selected Channel: $V_{IN} = 0 \text{ mV}_{p-p}$		45		dB
Output Offset Voltage			-480	480	m۷
Common Mode Output Voltage			5.0	7.0	V
Single Ended Output Resistance	f = 5.0 MHz			35	Ω
Internal Damping Resistor			560	1070	Ω

Symbol	Parameter	Conditions	Min	Max	Units	
R/W	R/W to Write	Delay to 90% of Write Current		1.0	(·	
	R/W to Read	Delay to 90% of 100 mV, 10 MHz Read Signal Envelope or to 90% Decay of Write Current		1.0	.0 μs	
CS	CS to Select	Delay to 90% of Write Current or to 90% of 100 mV, 10 MHz Read Signal Envelope		1.0	μs	
	CS to Unselect	Delay to 90% Decay of Write Current		1.0		
HS0 HS1 HS2	to Any Head	Delay to 90% of 100 mV, 10 MHz Read Signal Envelope		1.0	μs	
wus	Safe to Unsafe—TD1	$I_W = 50 \text{ mA}$	1.6	8.0	μs	
	Unsafe to Safe—TD2	$I_W = 20 \text{ mA}$		1.0	μ0	
Head Current	Propagation Delay—TD3, TD4	D4 Lh = 0 μ H, Rh = 0 Ω from 50% Points		25		
	Asymmetry	WDI has 50% Duty Cycle and 1 ns Rise/Fall Time	2		ns	
	Rise/Fall Time	10%-90% Points	20		1	

Connection Diagrams

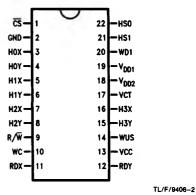


Top View

TL/F/9406-1



22-Lead Molded DIP

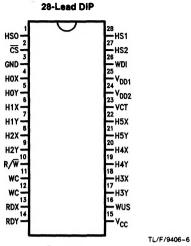


Top View

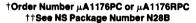
†Order Number μA1174PC or μA1174RPC ††See NS Package Number N22A

†For most current order information, contact your local sales office. ††For most current package information, contact product marketing.

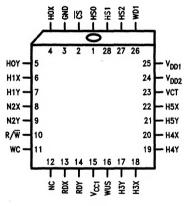
Connection Diagrams (Continued)



Top View



28-Lead PLCC



Top View



+For most current order information, contact your local sales office. ++For most current package information, contact product marketing. TL/F/9406-5

Functional Description

In the Write mode, the DP117-X/DP117-XR, μ A117-X/ μ A117-XR Series accepts TTL compatible write data pulses on the WDI lead. On the falling edge of each write data pulse, a current transition is made in the selected head. Head selection is accomplished via TTL input signals: HS0, HS1, HS2 (see Table II). Internal circuitry senses the following conditions:

- 1. Absence of data transitions.
- 2. Open circuit head connection.
- 3. Absence of write current.
- 4. Short circuit head connection.
- 5. Idle or read mode.

Pin Descriptions

Any or all of the above conditions would result in a high level on the write unsafe (WUS) output signal.

During read operations, the DP117-X amplifies the differential voltages appearing across the selected R/W head lead and applies the amplified signal differentially to data lines RDX and RDY.

Lead	Name	Function
CS	Chip Select	Chip Select High disables the read/write function of the device and forces idle mode. (TTL)
R/W	Read/Write Select	A Logic High places the devices in read mode and a Logic Low forces write mode. Refer to Table I. (TTL)
H0X, Y through H5X, Y	Read/Write Head Connections	The DP117 has five pairs of read/write connections. The X and Y phases are made consistent with the read output, RDX and RDY, phases. (Differential)
RDX, Y	Read Data Outputs	The chip has one pair of read data outputs which is multiplexed to the appropriate head connections. (Differential)
HS0 through HS2	Head Select Inputs	The eight read/write heads are addressed with the head select inputs. Refer to Table II. (TTL)
WC	Write Current Input	This lead sets the current level for the write mode. An external resistor is connected from this lead to ground, and write current is determined by the value of this resistor divided into the write current constant K, which is typically 140V.
WDI	Write Data Input	The write data input toggles the write current between the X and Y selected head connections. Write current is switched on the negative edge of WDI. The initial direction for write current is the X side of the switch and is set upon entering read or idle mode. (TTL)
V _{DD2}	Resistor Center Tap	In some versions (determined by lead availability) of the DP117-X series, a resistor may be connected between RCT and V_{DD1} to reduce internal power dissipation. If this resistor is not used, RCT must be connected externally to V_{DD1} .
VCT	Center Tap Voltage	The center tap output provides bias voltage for the head inputs in read and write mode. It should be connected to the center tap of the read/write heads.
WUS	Write Unsafe	A high logic level at the write unsafe output indicates a fault condition during write. Write unsafe will also be high during read and idle mode. (Open collector)

TABLE I. Read/Write Select

Operating Modes			
Chip Select CS	Read/Write R/W	Mode	
1	X	idle	
0	1	Read	
0	0	Write	

TABLE II. Head Select Inputs

	Head Selection					
HS0	HS1	HS2	Head Selected (Note 1)			
0	0	0	0			
1	0	0	1			
0	1	0	2			
1	1	0	3			
0	0	1	4			
1	0	1	5			

Note 1: If selected head is beyond the capacity of the DP117-X model, the open input condition on the selected input will be reported as an unsafe level at the WUS output.

